

# 2.5V or 3.3V, 200-MHz, 1:9 Clock Distribution Buffer

#### Features

- 2.5V or 3.3V operation
- 200-MHz clock support
- LVCMOS-/LVTTL-compatible inputs
- 9 clock outputs: drive up to 18 clock lines
- Synchronous Output Enable
- Output three-state control
- 250 ps max. output-to-output skew
- Pin compatible with MPC947, MPC9447
- · Available in Industrial and Commercial temp. range
- 32-pin TQFP package

#### Description

The CY29947 is a low-voltage 200-MHz clock distribution buffer with the capability to select one of two LVCMOS/LVTTL compatible clock inputs. The two clock sources can be used to provide for a test clock as well as the primary system clock. All other control inputs are LVCMOS/LVTTL compatible. The 9 outputs are LVCMOS or LVTTL compatible and can drive  $50\Omega$  series or parallel terminated transmission lines. For series terminated transmission lines, each output can drive one or two traces giving the device an effective fanout of 1:18. The outputs can also be three-stated via the three-state input TS#. Low output-to-output skews make the CY29947 an ideal clock distribution buffer for nested clock trees in the most demanding of synchronous systems.

The CY29947 also provides a synchronous output enable input for enabling or disabling the output clocks. Since this input is internally synchronized to the input clock, potential output glitching or runt pulse generation is eliminated.





### **Pin Description**<sup>[1]</sup>

Pin	Name	PWR	I/O	Description
3	TCLK0		I, PU	Test Clock Input
4	TCLK1		I, PU	Test Clock Input
2	TCLK_SEL		I, PU	Test Clock Select Input. When LOW, TCLK0 is selected. When asserted HIGH, TCLK1 is selected.
11, 13, 15, 19, 21, 23, 26, 28, 30	Q(8:0)	VDDC	0	Clock Outputs
5	SYNC_OE		I, PU	<b>Output Enable Input</b> . When asserted HIGH, the outputs are enabled and when set LOW the outputs are disabled in a LOW state.
6	TS#		I, PU	<b>Three-state Control Input</b> . When asserted LOW, the output buffers are three-stated. When set HIGH, the output buffers are enabled.
10, 14, 18, 22, 27, 31	VDDC			3.3V or 2.5V Power Supply for Output Clock Buffers
7	VDD			3.3V or 2.5V Power Supply
1, 8, 9, 12, 16, 17, 20, 24, 25, 29, 32	VSS			Common Ground

Note:

1. PD = internal pull-down, PU = internal pull-up.

#### **Output Enable/Disable**

The CY29947 features a control input to enable or disable the outputs. This data is latched on the falling edge of the input clock. When SYNC\_OE is asserted LOW, the outputs are disabled in a LOW state. When SYNC\_OE is set HIGH, the outputs are enabled as shown in *Figure 1*.



Figure 1. SYNC\_OE Timing Diagram



## Maximum Ratings<sup>[2]</sup>

Maximum Input Voltage Relative to $V_{SS}{:}\ldots\ldots$ , $V_{SS}{-}0.3V$
Maximum Input Voltage Relative to V <sub>DD</sub> :V <sub>DD</sub> + 0.3V
Storage Temperature:65°C to + 150°C
Operating Temperature:40°C to +85°C
Maximum ESD protection2kV
Maximum Power Supply:
Maximum Input Current:

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation,  $V_{\text{in}}$  and  $V_{\text{out}}$  should be constrained to the range:

$$V_{SS} < (V_{in} \text{ or } V_{out}) < V_{DD}$$

Unused inputs must always be tied to an appropriate logic voltage level (either  $V_{SS}$  or  $V_{DD}$ ).

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V <sub>IL</sub>	Input Low Voltage		V <sub>SS</sub>		0.8	V
V <sub>IH</sub>	Input High Voltage		2.0		V <sub>DD</sub>	V
IIL	Input Low Current <sup>[3]</sup>				-100	μA
I <sub>IH</sub>	Input High Current <sup>[3]</sup>				10	μA
V <sub>OL</sub>	Output Low Voltage <sup>[4]</sup>	I <sub>OL</sub> = 20 mA			0.4	V
V <sub>OH</sub>	Output High Voltage <sup>[4]</sup>	I <sub>OH</sub> = -20 mA, V <sub>DD</sub> = 3.3V	2.5			V
		I <sub>OH</sub> = -20 mA, V <sub>DD</sub> = 2.5V	1.8			
I <sub>DDQ</sub>	Quiescent Supply Current			5	7	mA
I <sub>DD</sub>	Dynamic Supply Current	$V_{DD}$ = 3.3V, Outputs @ 100 MHz, CL = 30 pF		120		mA
		V <sub>DD</sub> =3.3V, Outputs @ 160 MHz, CL = 30 pF		200		
		V <sub>DD</sub> =2.5V, Outputs @ 100 MHz, CL = 30 pF		85		
		V <sub>DD</sub> =2.5V, Outputs @ 160 MHz, CL = 30 pF		140		1
Zout	Output Impedance	V <sub>DD</sub> = 3.3V	12	15	18	Ω
		V <sub>DD</sub> = 2.5V	14	18	22	1
C <sub>in</sub>	Input Capacitance			4		pF

**DC Parameters:**  $V_{DD} = V_{DDC} = 3.3V \pm 10\%$  or 2.5V  $\pm 5\%$ , Over the specified temperature range

Notes:

2. 3. 4. **Multiple Supplies:** The voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required. Inputs have pull-up/pull-down resistors that effect input current. Driving series or parallel terminated  $50\Omega$  (or  $50\Omega$  to  $V_{DD}/2$ ) transmission lines.



Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
Fmax	Input Frequency <sup>[6]</sup>	V <sub>DD</sub> = 3.3V			200	MHz
		V <sub>DD</sub> = 2.5V			170	
Tpd	TCLK To Q Delay <sup>[6]</sup>	$V_{DD} = 3.3 V$	4.75		9.25	ns
		V <sub>DD</sub> = 2.5V	6.50		10.50	
FoutDC	Output Duty Cycle <sup>[6, 7]</sup>	Measured at V <sub>DD</sub> /2	45		55	%
tpZL, tpZH	Output Enable Time (all outputs)		2		10	ns
tpLZ, tpHZ	Output Disable Time (all outputs)		2		10	ns
Tskew	Output-to-Output Skew <sup>[6, 8]</sup>			150	250	ps
Tskew(pp)	Part-to-Part Skew <sup>[9]</sup>				2.0	ns
Ts	Set-up Time <sup>[6, 10]</sup>	SYNC_OE to TCLK	0.0			ps
Th	Hold Time <sup>[6, 10]</sup>	TCLK to SYNC_OE	1.0			ps
Tr/Tf	Output Clocks Rise/Fall Time <sup>[8]</sup>	0.8V to 2.0V, V <sub>DD</sub> = 3.3V	0.20		1.0	ns
		0.6V to 1.8V, V <sub>DD</sub> = 2.5V	0.20		1.3	

Notes:

Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with loaded outputs.
Outputs driving 50Ω transmission lines.
50% input duty cycle.
See *Figure 2*.
Part-to-Part skew at a given temperature and voltage.
Set-up and hold times are relative to the falling edge of the input clock





Figure 2. LVCMOS\_CLK CY29947 Test Reference for V\_{CC} = 3.3V and V\_{CC} = 2.5V



Figure 3. LVCMOS Propagation Delay (TPD) Test Reference



Figure 4. Output Duty Cycle (FoutDC)



Figure 5. Output-to-Output Skew tsk(0).



### **Ordering Information**

Part Number	Package Type	Production Flow
CY29947AI	32 Pin TQFP	Industrial, –40°C to +85°C
CY29947AIT	32 Pin TQFP - Tape and Reel	Industrial, –40°C to +85°C
CY29947AC	32 Pin TQFP	Commercial, 0°C to +70°C
CY29947ACT	32 Pin TQFP - Tape and Reel	Commercial, 0°C to +70°C

#### **Package Drawing and Dimensions**





All product and company names mentioned in this document may be the trademarks of their respective holders.

© Cypress Semiconductor Corporation, 2002. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress Semiconductor product. Nor does it convey or imply any license under patent or other rights. Cypress Semiconductor does not authorize its products for use as critical components in life-support systems where a malfurnion or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress Semiconductor products in life-support systems where a malfurne as lirities all risk of such use and in doing so indemnifies Cypress Semiconductor against all charges.



# **Revision History**

Document Title: CY29947 2.5V or 3.3V, 200-MHz, 1:9 Clock Distribution Buffer Document Number: 38-07287					
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change	
**	111098	02/07/02	BRK	New data sheet	
*A	116781	08/14/02	HWT	Added Commercial Temperature Range in the ordering information	
*В	118462	09/09/02	HWT	Corrected the Package Drawing and Dimension in page 6 from 32 LQFP to 32 TQFP	
*C	122879	12/22/02	RBI	Added power up requirements to Maximum Ratings	